



Failure Modes, Effects and Diagnostic Analysis

Project:

9113 Temperature / mA converter

Customer:

PR electronics A/S

Rønde

Denmark

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Management summary

This report summarizes the results of the hardware assessment in the form of a Failure Modes, Effects, and Diagnostic Analysis (FMEDA) of the 9113 Temperature / mA converter with hardware version PR9113-1-06A and software versions 91136310P (Input CPU), 91136010P (Main CPU) and 91136216P (Output CPU). Table 1 gives an overview of the considered product variants.

A Failure Modes, Effects, and Diagnostic Analysis is one of the steps taken to achieve functional safety assessment of a device per IEC 61508 or ISO 13849. From the FMEDA, failure rates are determined and consequently the safety metrics for the corresponding standard can be calculated for a subsystem.

The FMEDA that is described in this report concerns only the hardware of the 9113 Temperature / mA converter. For full assessment purposes all requirements of IEC 61508 or ISO 13849 must be considered.

Table 1: Overview of the considered Product variants

	Description	Suffix	Variant description
[P1]	9113	AA	Standard version, single channel
[P2]	9113	BA	Hazardous area / "Ex" version, single channel
[P3]	9113	AB	Standard version, dual channel
[P4]	9113	BB	Hazardous area / "Ex" version, dual channel

For safety applications only the described variants with the described hardware and software versions of the 9113 Temperature / mA converter have been considered. Any other variants and configurations are not covered by this report.

The 9113 Temperature / mA converter can be considered as a Type B¹ element with a hardware fault tolerance (HFT) of 0.

The failure modes and failure rates used in this analysis are from the *exida* Electrical Component Reliability Handbook [N2] for Profile 1. They meet the *exida* criteria for Route 2_H (see Appendix 4). Therefore, the 9113 Temperature / mA converter can be classified as a 2_H device when the listed failure rates are used. The analysis resulted in a DC (Diagnostic Coverage) of over 60%.

The failure rates are valid for the useful life of the 9113 Temperature / mA converter (see Appendix 2) when operating as defined in the considered scenarios.

When 2_H data is used for all of the devices in an element, then the element meets the hardware architectural constraints up to SIL 2 at HFT=0 for low demand mode applications or SIL 2 / SIL 3 at HFT=1 for high and low demand mode applications.

The two channels on the dual channel devices shall not be used in the same safety function, e.g. to increase the hardware fault tolerance to achieve a higher SIL, as they contain common components. The FMEDA applies to either channel used in a single safety function. The two channels may be used in separate safety functions if regard is taken of the possibility of common failures.

¹ Type B element: "Complex" element (using micro controllers or programmable logic); for details see 7.4.4.1.3 of IEC 61508-2:2010.

It is assumed that the connected safety logic solver is configured as per the NAMUR NE43 signal ranges, i.e. the 9113 Temperature / mA converter with 4..20 mA current output communicates detected faults by an alarm output current $\leq 3,6\text{mA}$ or $\geq 21\text{mA}$.

Assuming that, the application program in the safety logic solver does not automatically trip on these failures, these failures have been classified as dangerous detected failures. The following table shows how the above stated requirements are fulfilled.

Table 2: Summary for the 9113 Temperature / mA converter – IEC 61508 failure rates

	<i>exida</i> Profile 1 ²
Failure category	Failure rates (in FIT)
Safe Detected (λ_{SD})	0
Safe Undetected (λ_{SU})	0
Dangerous Detected (λ_{DD})	404
Fail detected (detected by internal diagnostics)	266
Fail Low (detected by safety logic solver)	119
Safe Undetected (λ_{SU}) ³	14
Fail high (detected by safety logic solver)	5
Dangerous Undetected (λ_{DU})	66 ⁴
Total failure rate (safety function)	470
DC ⁵	86%

² For details see Appendix 3.

³ These λ_{SU} failures results in a power loss event at the device and will be detected as a “Fail low” by the safety logic solver.

⁴ This value corresponds to a PFH of 6.58E-08 1/h. A fault reaction time of 30 seconds requires also that a connected device can detect the output state within a time that allows reacting within the process safety time.

⁵ According to the Route 2_H approach from IEC 61508, the DC value together with the device type is sufficient to derive the SIL level of the device. See chapter 4.4 for more details.

Table 3: Safety metrics according to ISO 13849-1

MTTF_D (years)	243 (High)
DC_{avg}	86 % (Low)
Average frequency of a dangerous failure per hour (PFH) ⁶	6.58E-08 1/h
Performance Level (PL) ⁷	d

These failure rates are valid for the useful lifetime of the product (see Appendix 2).

⁶ The PFH value of 6.51E-08 1/h is only valid if the demand rate for the Safety Function is at least 100 times lower than the worst-case internal fault detection time.

⁷ The complete Safety Function according to ISO 13849-1 needs to be evaluated to determine the overall achieved Performance Level. The Performance Level listed here only considers the MTTF_D, DC_{avg} and PFH value of the device itself.

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1 Purpose and Scope

This document shall describe the results of the hardware assessment carried out on the 9113 Temperature / mA converter with hardware version PR9113-1-06A and software versions 91136310P (Input CPU), 91136010P (Main CPU) and 91136216P (Output CPU).

The FMEDA builds the basis for an evaluation whether a sensor / logic / final-element subsystem, including the product, meets the average Probability of Failure on Demand (PFD_{AVG}) / Probability of dangerous Failure per hour (PFH) requirements and the architectural constraints / minimum hardware fault tolerance requirements per IEC 61508 or ISO 13849.

It **does not** consider any calculations necessary for proving intrinsic safety or an evaluation of the correct device behavior in general. This FMEDA **does not** replace a full assessment according to IEC 61508 or ISO 13849.

2 Project management

2.1 *exida*

exida is one of the world's leading accredited Certification Bodies and knowledge companies specializing in automation system safety, availability, and cybersecurity with over 500 person years of cumulative experience in functional safety, alarm management, and cybersecurity. Founded by several of the world's top reliability and safety experts from manufacturers, operators and assessment organizations, *exida* is a global corporation with offices around the world. *exida* offers training, coaching, project oriented consulting services, safety engineering tools, detailed product assurance and ANSI accredited functional safety and cybersecurity certification. *exida* maintains a comprehensive failure rate and failure mode database on electronic and mechanical equipment and a comprehensive database on solutions to meet safety standards such as IEC 61508 or ISO 13849.

2.2 Roles of the parties involved

PR electronics A/S
 Manufacturer of the 9113 Temperature / mA converter. PR electronics A/S performed the original FMEDA of the devices under consideration.

exida
 Reviewed the original FMEDA from PR electronics A/S and transferred it to the latest SILcal X format. *exida* also updated the related FMEDA report to the *exida* CRD Route 2_H compliant failure rate data.

PR electronics A/S contracted *exida* in September 2023 with the update of the hardware assessment of the above mentioned device.

2.3 Standards / Literature used

The services delivered by *exida* were performed based on the following standards / literature.

[N1]	IEC 61508-2:2010	Functional Safety of Electrical/Electronic/Programmable Electronic Safety-Related Systems
[N2]	ISO 13849-1:2023	Safety of machinery — Safety-related parts of control systems — Part 1: General principles for design
[N3]	Component Reliability Database Handbook, 5th Edition, 2021 Vol. 1 – Electrical Components	<i>exida</i> LLC, Component Reliability Database Handbook, 5th Edition, 2021 Vol. 1 – Electrical Components ISBN 978-1-934977-09-5

2.4 *exida* tools used

[T1]	SILcal V6	FMEDA Tool
[T2]	exSILentia V4.13.0	SIL Verification Tool

2.5 Reference documents

2.5.1 Documentation provided by the customer

[D1]	9113-1-06A-PDF.pdf of 07.02.20	Schematic drawings, No. 9113-1-V6AR0-SH1 (page 1 to 7), based on HW Rev. 9113-1-06A
[D2]	9113-BA-2005.pdf of 07.09.09	Components of housing for 9113
[D3]	9113SMDA_2055.xlsx of 24.05.23	List of components (BOM) for 9113 revision 9113SMDA- 2055
[D4]	9113 Hardware Fault Insertion Test Report.doc of 16.12.2011	Hardware fault insertion test report revision V5R0
[D5]	9113 Circuit description V1R0.doc of 13.08.09	Circuit description revision V1R0
[D6]	9113 CPU failure distribution estimation V0R3.xls of 26.08.09	Failure distribution for used CPUs revision V0R3
[D7]	9113 FMEDA single channel V0R15.xls of 13.11.23	FMEDA results file revision V0R15 generated by customer, based on HW Rev. 9113-1-V4R0 and BOM Rev. 9113SMDA- 2015
[D8]	New A variant to the 9000 series of transmitters with grey terminals.msg of 15.05.14	Description of changes between Ex and standard versions
[D9]	9113 Derating Analysis.xls of 15.12.2011	Derating analysis for 9113, based on schematic Rev. V4R1

The list above only means that the referenced documents were provided as basis for the FMEDA, but it does not mean that *exida* checked the correctness and completeness of these documents.

The FMEDA results file [D7] is also valid for the latest HW Rev. 9113-1-06A, where the schematic file [D1] is based on. This is documented and insured by the customer in the version history of the BOM file [D3].

2.5.2 Documentation generated by *exida*

[R1]	9113 FMEDA single channel_CRD_5th_Ed_FIT_values.xls of 02.02.24	FMEDA results file based on [D7] with Route 2 _H compliant failure rate data used from the <i>exida</i> CRD [N3]
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3 Product Description

The 9113 Temperature / mA converter converts various sensor input signals to a 4..20 mA current output signal and provides an isolation of input signals from hazardous areas, temperature or standard signal (e.g. 4..20mA, 0..10V, etc.) signals, to any superior logic solver system or safety PLC.

These sensors/input signals may vary as such as RTD, thermocouple input, linear current/voltage input, 2(3 or 4)-wire transmitter, linear resistance and potentiometer input.

The 9113 Temperature / mA converter is available in a single (type 9113BA / 9113AA) and a dual channel version (type 9113BB / 9113AB).

The 9113BB / 9113AB - Temperature / mA Converter has two separate measurement channels. The required level of independence between them is provided by the clear separation of the channel related hardware circuitry which have their own pair of input / output micro-controllers, including isolation, meeting applicable requirement for ex-products (9113BB) and provide protection of the effect of faults related to power distribution in the channel-related circuitry.

Figure 1 gives an overview of the considered device.

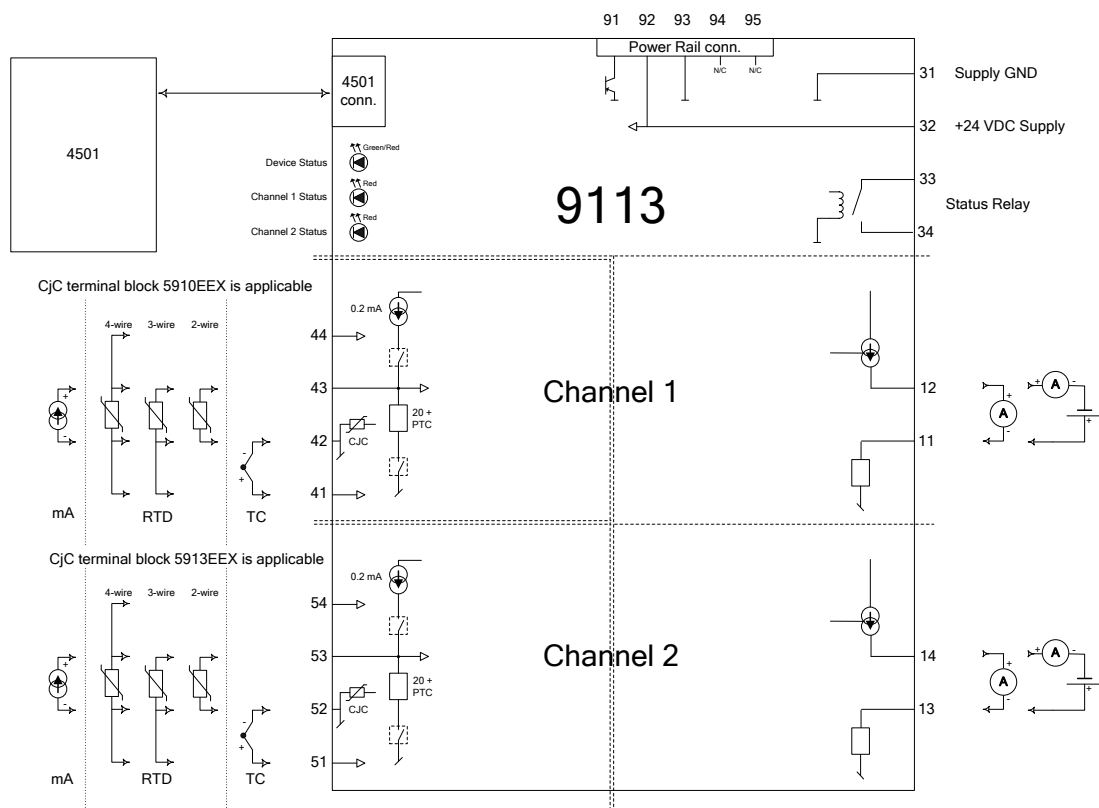


Figure 1: Block diagram of the dual channel variants

The 9113 Temperature / mA converter is classified as a Type B⁸ element according to IEC 61508, having a hardware fault tolerance of 0.

⁸ Type B element: "Complex" element (using micro controllers or programmable logic); for details see 7.4.4.1.3 of IEC 61508-2:2010.

4 Failure Modes, Effects, and Diagnostic Analysis

The original Failure Modes, Effects, and Diagnostic Analysis was done by **PR electronics A/S** and is documented in [D7]. *exida* updated the failure rates from that report to the *exida* CRD (see [N3]) and created the FMEDA documented in [R1]. The analysis presented in this chapter is based on [R1].

When the effect of a certain component failure mode could not be analyzed theoretically, the failure modes were introduced on component level and the effects of these failure modes were examined on system level (see fault insertion test report [D4]). This resulted in failures that can be classified according to the following failure categories.

4.1 Failure categories description

In order to judge the failure behavior of the 9113 Temperature / mA converter, the following definitions for the failure of the product were considered.

Fail-Safe State	The fail-safe state is defined as the output reaching the user defined threshold value.
Fail Safe	Failure that causes the subsystem to go to the defined fail-safe state without a demand from the process.
Fail Dangerous	Failure that corrupts the measured value by more than 2% of full span (0.32mA) and therefore has the potential to not respond to a demand from the process (i.e. being unable to go to the defined fail-safe state).
Fail Dangerous Undetected	Failure that is dangerous and that is not being diagnosed by internal diagnostics.
Fail Dangerous Detected	Failure that is dangerous but is detected by internal diagnostics and causes the output signal to go to the predefined alarm state.
Fail High	A fail high failure (H) is defined as a failure that causes the output signal to go to the over-range or high alarm output current (> 21mA).
Fail Low	A fail low failure (L) is defined as a failure that causes the output signal to go to the under-range or low alarm output current (< 3.6mA).
No Effect	Failure mode of a component that plays a part in implementing the safety function but is neither a safe failure nor a dangerous failure and does not corrupt the measured value by more than 2% of full span (0.32mA).
Annunciation	Failure that does not directly impact safety but does impact the ability to detect a future fault (such as a fault in a diagnostic circuit).
No Part	Component that plays no part in implementing the safety function but is part of the circuit diagram and is listed for completeness. When calculating the DC, this failure mode is not taken into account. It is also not part of the total failure rate.



Depending on the application, a Fail High or a Fail Low failure can either be safe or dangerous and may be detected or undetected depending on the programming of the logic solver. Consequently, during a Safety Integrity Level (SIL) verification assessment the Fail High and Fail Low failure categories need to be classified as safe or dangerous, detected or undetected.

The “Annunciation” failures are provided for those who wish to do reliability modeling more detailed than required by IEC 61508.

4.2 Methodology – FMEDA, Failure rates

4.2.1 FMEDA

A Failure Modes and Effects Analysis (FMEA) is a systematic way to identify and evaluate the effects of different component failure modes, to determine what could eliminate or reduce the chance of failure, and to document the system under consideration.

An FMEDA (Failure Mode Effect and Diagnostic Analysis) is an FMEA extension. It combines standard FMEA techniques with extensions to identify online diagnostics techniques and the failure modes relevant to safety instrumented system design. It is a technique recommended to generate failure rates for each important category (safe detected, safe undetected, dangerous detected, dangerous undetected, fail high, fail low) in the safety models. The format for the FMEDA is an extension of the standard FMEA format from MIL STD 1629A, Failure Modes and Effects Analysis.

4.2.2 Failure rates

The failure modes and failure rates used in this analysis are from the *exida* Electrical Component Reliability Handbook [N3] for environmental profile 1 (see Appendix 3). The rates were chosen in a way that is appropriate for safety integrity level verification calculations and the intended applications. It is expected that the actual number of field failures due to random events will be less than the number predicted by these failure rates.

For hardware assessment according to IEC 61508 or ISO 13849 only random equipment failures are of interest. It is assumed that the equipment has been properly selected for the application and is adequately commissioned such that early life failures (infant mortality) may be excluded from the analysis.

Early life failures (infant mortality) are not included in the failure rate prediction as it is assumed that some level of commission testing is done. End of life failures are not included in the failure rate prediction as useful life is specified.

Failures caused by external events should be considered as random failures. Examples of such failures are loss of power or physical abuse.

The assumption is also made that the equipment is maintained per the requirements of IEC 61508 or IEC 61511 and therefore a preventative maintenance program is in place to replace equipment before the end of its “useful life”.

The user of these numbers is responsible for determining the failure rate applicability to any particular environment.

Accurate plant specific data may be used to check validity of the failure rate data. If a user has data collected from a good proof test reporting system such as *exida* SILStat™ that indicates higher failure rates, the higher numbers shall be used.

4.2.3 Assumptions

The following assumptions have been made during the Failure Modes, Effects, and Diagnostic Analysis of the 9113 Temperature / mA converter.

- Failure rates are constant, wear out mechanisms are not included.
- Propagation of failures is not relevant.
- The device is installed per manufacturer's instructions.
- Failures during parameterization are not considered.
- Sufficient tests are performed prior to shipment to verify the absence of vendor and/or manufacturing defects that prevent proper operation of specified functionality to product specifications or cause operation different from the design analyzed.
- The Mean Time To Restoration (MTTR) after a safe failure is 24 hours.
- External power supply failure rates are not included.
- The time of a connected safety PLC to react on a dangerous detected failure and to bring the process to the safe state is identical to MTTR.
- Only the described versions are used for safety applications.
- Only one input and one output are part of the considered safety function.
- The application program in the safety logic solver is configured according to NAMUR NE43 to detect under-range and over-range failures and does not automatically trip on these failures; therefore these failures have been classified as dangerous detected failures.
- Materials are compatible with process conditions.
- The measurement / application limits (including pressure and temperature ranges) are considered.
- Short circuit and lead breakage detection are activated.
- The worst-case internal fault detection time is 30 seconds. Therefore, a demand for the safety function in high demand mode is only possible every 3000 seconds⁹, which corresponds to 50 minutes.
- Soft Error Rates (SER) were considered for relative neutron flux of 4.5 corresponding to 1,600 meters above sea.

4.3 FMEDA Results

For the calculations the following has to be noted:

$$\lambda_{\text{total}} = \lambda_{\text{SD}} + \lambda_{\text{SU}} + \lambda_{\text{DD}} + \lambda_{\text{DU}}$$

IEC 61508:

$$\text{DC} = \lambda_{\text{DD}} / (\lambda_{\text{DD}} + \lambda_{\text{DU}})$$

ISO 13849-1:

$$\text{MTTF}_D [\text{years}] = 1 / ((\lambda_{\text{DD}} + \lambda_{\text{DU}}) * 24 * 365)$$

$$\text{PFH} = \lambda_{\text{DU}}$$

$$\text{DC}_{\text{avg}} = \lambda_{\text{DD}} / (\lambda_{\text{DD}} + \lambda_{\text{DU}})$$

⁹ See IEC 61508-2:2010, paragraph 7.4.4.1.4 and ISO 13849-1:2023, paragraph 6.1.3.2.4

4.3.1 9113 Temperature / mA converter

The FMEDA carried out on the 9113 Temperature / mA converter in the product variants [P1] to [P4], under the assumptions described in section 4.2.3 and the definitions given in section 4.1 and 4.2 leads to the following failure rates:

	<i>exida</i> Profile 1 ¹⁰
Failure category	Failure rates (in FIT)
Safe Detected (λ_{SD})	0
Safe Undetected (λ_{SU})	0
Dangerous Detected (λ_{DD})	404
Fail detected (detected by internal diagnostics)	266
Fail low (detected by safety logic solver)	119
Safe Undetected (λ_{SU}) ¹¹	14
Fail high (detected by safety logic solver)	5
Dangerous Undetected (λ_{DU})	66 ¹²

Annunciation (λ_A)	29
No effect ($\lambda_{\#}$)	167
No part (λ_{-})	301

Total failure rate (safety function)	470
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DC ¹³	86%
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¹⁰ For details see Appendix 3.

¹¹ These λ_{SU} failures results in a power loss event at the device and will be detected as a “Fail low” by the safety logic solver.

¹² This value corresponds to a PFH of 6.58E-08 1/h. A fault reaction time of 30 seconds requires also that a connected device can detect the output state within a time that allows reacting within the process safety time.

¹³ According to the Route 2_H approach from IEC 61508, the DC value together with the device type is sufficient to derive the SIL level of the device. See chapter 4.4 for more details.

Safety metrics according to ISO 13849-1

MTTF _D (years)	243 (High)
DC _{avg}	86 % (Low)
Average frequency of a dangerous failure per hour (PFH) ¹⁴	6.58E-08 1/h
Performance Level (PL) ¹⁵	d

These failure rates are valid for the useful lifetime of the product (see Appendix 2).

¹⁴ The PFH value of 6.58E-08 1/h is only valid if the demand rate for the Safety Function is at least 100 times lower than the worst-case internal fault detection time.

¹⁵ The complete Safety Function according to ISO 13849-1 needs to be evaluated to determine the overall achieved Performance Level. The Performance Level listed here only considers the MTTF_D, DC_{avg} and PFH value of the device itself.

4.4 Architectural Constraints

The architectural constraint type for the 9113 Temperature / mA converter is B. The hardware fault tolerance of the device is 0.

According to IEC 61508 the architectural constraints of an element must be determined. This can be done by following the 1_H approach according to 7.4.4.2 of IEC 61508-2 or the 2_H approach according to 7.4.4.3 of IEC 61508-2.

The 1_H approach involves calculating the Safe Failure Fraction (SFF) for the entire element.

The 2_H approach involves assessment of the reliability data for the entire element according to 7.4.4.3.3 of IEC 61508-2.

This FMEDA analysis uses the 2_H approach with the 2_H qualified failure rates from the *exida* component reliability database [N3] (see also Appendix 4). To apply the 2_H approach on a Type B device, the diagnostic coverage has to be at least 60%.

The analysis shows that the 9113 Temperature / mA converter has a diagnostic coverage of 86% (assuming that the logic solver is programmed to detect over-scale and under-scale outputs) and therefore meets hardware architectural constraints for up to SIL 2 as a single device.

When 2_H data is used for all of the devices in an element, then the element meets the hardware architectural constraints up to SIL 2 at HFT=0 for low demand mode applications or SIL 2 / SIL 3 at HFT=1 for high and low demand mode applications.

As the 9113 Temperature / mA converter is only one part of an element, the architectural constraints should be determined for the entire sensor element.

The SIS designer is responsible for meeting other requirements of applicable standards for any given SIL.

5 Using the FMEDA results

Using the failure rate data given in section 4.3.1 and the failure rate data for the associated element devices, an average Probability of Failure on Demand (PFD_{AVG}) calculation can be performed for the entire Safety Instrumented Function (SIF).

Probability of Failure on Demand (PFD_{AVG}) calculation uses several parameters, many of which are determined by the particular application and the operational policies of each site. Some parameters are product specific and the responsibility of the manufacturer. Those manufacturer specific parameters are given in this third party report.

To perform an average Probability of Failure on Demand (PFD_{AVG}) calculation is the responsibility of the owner/operator of a process and is often delegated to the SIF designer. Product manufacturers can only provide a PFD_{AVG} by making many assumptions about the application and operational policies of a site. Therefore, use of these numbers requires complete knowledge of the assumptions and a match with the actual application and site.

Probability of Failure on Demand (PFD_{AVG}) calculation is best accomplished with *exida's* exSILentia tool.

The failure rates for all the devices of the Safety Instrumented Function and the corresponding proof test coverages are required to perform the PFD_{AVG} calculation. The proof test coverage of the suggested proof test for the 9113 Temperature / mA converter is listed in Appendix 1.1. This has to be combined with the dangerous failure rates after proof test for other devices to establish the proof test coverage for the entire Safety Instrumented Function.

When performing testing at regular intervals, the 9113 Temperature / mA converter contribute less to the overall PFD_{AVG} of the safety instrumented function.

The following section gives a simplified example on how to apply the results of the FMEDA.

5.1 Example PFD_{AVG} / PFH calculation

An average Probability of Failure on Demand (PFD_{AVG}) calculation is performed for a single (1oo1) 9113 Temperature / mA converter with *exida's* exSILentia tool. The failure rate data used in this calculation are given in section 4.3.1.

A mission time of 10 years has been assumed, a Mean Time To Restoration of 24 hours and a maintenance capability of 100%. Table 4 lists the results for different proof test intervals considering an average proof test coverage of 95% (see Appendix 1.1).

Table 4: 9113 Temperature / mA converter – PFD_{AVG} / PFH values

Device variants	PFH	T[Proof]	
		1 year	4 years
[P1] - [P4]	6.58 E-08 1/h	PFD _{AVG} = 4.84 E-04	PFD _{AVG} = 1.28 E-03

For SIL2 the overall PFD_{AVG} shall be better than 1.00E-02 and the PFH shall be better than 1.00E-06 1/h.

As the 9113 Temperature / mA converter is contributing to the entire safety function, it should only consume a certain percentage of the allowed range. Assuming 10% of this range as a reasonable budget, they should be better than or equal to a PFD_{AVG} value of 1.00E-03 or a PFH value of 1.00E-07 1/h, respectively.

With a proof test interval of one year, the calculated PFD_{AVG} / PFH values are within the allowed range for SIL 2 according to table 2 of IEC 61508-1:2010 and do fulfill the assumption to not claim more than 10% of the allowed range, i.e. to be better than or equal to 1.00E-03 or 1.00E-07 1/h, respectively.

The resulting PFD(t) / PFD_{AVG} graph generated with exSILentia for a proof test interval of one year is displayed in Figure 2.

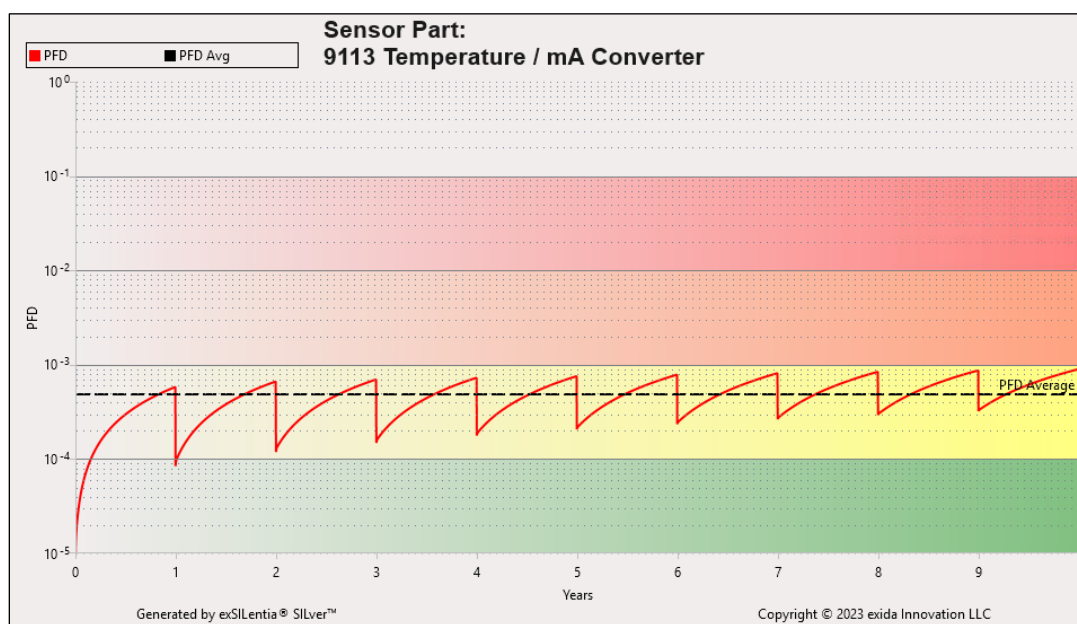


Figure 2: PFD(t) / PFD_{AVG}

6 Terms and Definitions

Internal Diagnostics	Tests performed internally by the device or, if specified, externally by another device without manual intervention.
Fault tolerance	Ability of a functional unit to continue to perform a required function in the presence of faults or errors (IEC 61508-4, 3.6.3).
DC / DC _{avg}	Diagnostic Coverage of dangerous failures (in %)
FIT	Failure In Time (1×10^{-9} failures per hour)
FMEDA	Failure Modes, Effects, and Diagnostic Analysis
HFT	Hardware Fault Tolerance A hardware fault tolerance of N means that N+1 is the minimum number of faults that could cause a loss of the safety function.
High demand mode	Mode, where the safety function is only performed on demand, in order to transfer the EUC into a specified safe state, and where the frequency of demands is greater than one per year.
Low demand mode	Mode, where the safety function is only performed on demand, in order to transfer the EUC into a specified safe state, and where the frequency of demands is no greater than one per year.
MTTF _D	Mean Time To dangerous Failure
PFD _{AVG}	Average Probability of Failure on Demand
PFH	Probability of dangerous Failure per Hour
PL	Performance Level ISO 13849-1: Discrete level used to specify the ability of safety-related parts of control systems to perform a safety function under foreseeable conditions.
SFF	Safe Failure Fraction, summarizes the fraction of failures which lead to a safe state plus the fraction of failures which will be detected by automatic diagnostic measures and lead to a defined safety action.
SIF	Safety Instrumented Function
SIL	Safety Integrity Level IEC 61508: discrete level (one out of a possible four), corresponding to a range of safety integrity values, where safety integrity level 4 has the highest level of safety integrity and safety integrity level 1 has the lowest. IEC 62061: discrete level (one out of a possible three) for specifying the safety integrity requirements of the safety-related control functions to be allocated to the SRECS, where safety integrity level three has the highest level of safety integrity and safety integrity level one has the lowest.
SIS	Safety Instrumented System – Implementation of one or more Safety Instrumented Functions. A SIS is composed of any combination of sensor(s), logic solver(s), and final element(s).
Type B element	“Complex” element (using complex components such as micro controllers or programmable logic); for details see 7.4.4.1.3 of IEC 61508-2
T[Proof]	Proof Test Interval

7 Status of the document

7.1 Liability

exida prepares reports based on methods advocated in International standards. Failure rates are obtained from a collection of industrial databases. *exida* accepts no liability whatsoever for the use of these numbers or for the correctness of the standards on which the general calculation methods are based.

Due to future potential changes in the standards, best available information and best practices, the current FMEDA results presented in this report may not be fully consistent with results that would be presented for the identical product at some future time. As a leader in the functional safety market place, *exida* is actively involved in evolving best practices prior to official release of updated standards so that our reports effectively anticipate any known changes. In addition, most changes are anticipated to be incremental in nature and results reported within the previous three year period should be sufficient for current usage without significant question.

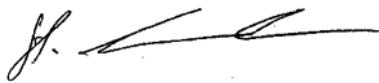
Most products also tend to undergo incremental changes over time. If an *exida* FMEDA has not been updated within the last three years and the exact results are critical to the SIL verification, you may wish to contact the product vendor to verify the current validity of the results.

7.2 Releases

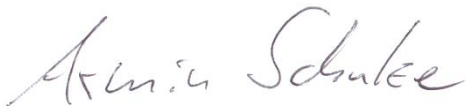
Version History:	V3R3:	Added Appendix 5 with typical failure rates of thermocouples for the failure modes “open circuit”, “short circuit” and “temperature drift”; September 26, 2024
	V3R2:	Merged AU and AD failures to general annunciation failures. Those are not part of the analysis; February 1 st , 2024
	V3R1:	Includes metrics according to ISO 13849-1, November 15, 2023
	V3R0:	Updated to IEC 61508:2010; Route 2H, October 16, 2023
	V2R1:	Editorial changes; July 10, 2014
	V2R0:	Non-Ex versions added; July 8, 2014
	V1R1:	Purpose and Scope section modified; September 27, 2010
	V1R0:	Review comments incorporated; October 19, 2009
	V0R1:	Initial version; October 2, 2009
Authors:	V3R1 to V3R3	Armin Schulze
	V3R0:	Jürgen Hochhaus
	V0R1 to V2R1	Stephan Aschenbrenner, Alexander Dimov
Review:	V3R3:	Stephan Aschenbrenner (<i>exida</i>), September 26, 2024
	V3R1:	Stephan Aschenbrenner (<i>exida</i>), November 15, 2023
	V3R0:	Stephan Aschenbrenner (<i>exida</i>), November 01, 2023 Flemming Svanholm Sørensen (PR electronics A/S); November 03, 2023
	V2R0:	Flemming Svanholm Sørensen (PR electronics A/S); July 10, 2012
	V0R1:	Rachel Amkreutz (<i>exida</i>); October 13, 2009 Hans Jørgen Eriksen (PR electronics A/S); October 13, 2009

Release status: Released to PR electronics A/S

7.3 Release Signatures



Dipl.-Ing. (Univ.) Stephan Aschenbrenner, Partner



Dipl.-Ing. (Univ.) Armin Schulze, Safety Engineer

Appendix 1: Possibilities to reveal dangerous undetected faults during the proof test

According to section 7.4.5.2 f) of IEC 61508-2 proof tests shall be undertaken to reveal dangerous faults which are undetected by diagnostic tests.

This means that it is necessary to specify how dangerous undetected faults which have been noted during the FMEDA can be detected during proof testing.

Appendix 1.1: Possible proof tests to detect dangerous undetected faults

A suggested proof test consists of the following steps, as described in Table 5.

Table 5: Suggested proof test

Step	Action
1	Bypass the safety PLC or take other appropriate action to avoid a false trip.
2	Use the 45XX to command the transmitter (with EN:SIM) to go to the high alarm current output and verify that the analog current reaches that value. This test for compliance voltage problems such as a low loop power supply voltage or increased wiring resistance. This also tests for other possible failures.
3	Use the 45XX to command to the transmitter (with EN:SIM) to go to the low alarm current output and verify that the analog current reaches that value. This tests for possible quiescent current related failures
4	Perform a two-point calibration of the transmitter.
5	Restore the loop to full operation.
6	Remove the bypass from the safety PLC or otherwise restore normal operation.

This test will detect approximately 95% of possible “DU” failures in the transmitter and the connected sensing element.

Appendix 2: Impact of lifetime of critical components on the failure rate

According to section 7.4.9.5 of IEC 61508-2, a useful lifetime, based on experience, should be determined and used to replace equipment before the end of useful life.

Although a constant failure rate is assumed by the *exida* FMEDA prediction method (see section 4.2) this only applies provided that the useful lifetime¹⁶ of components is not exceeded. Beyond their useful lifetime, the result of the probabilistic calculation method is likely optimistic, as the probability of failure significantly increases with time. The useful lifetime is highly dependent on the subsystem itself and its operating conditions.

This assumption of a constant failure rate is based on the bathtub curve. Therefore, it is obvious that the probability calculation is only valid for components which have this constant domain and that the validity of the calculation is limited to the useful lifetime of each component.

It is assumed that early failures are detected to a huge percentage during the installation period and therefore the assumption of a constant failure rate during the useful lifetime is valid.

It is the responsibility of the end user to maintain and operate the 9113 Temperature / mA converter per manufacturer's instructions.

Note 3 in IEC 61508-2 states that experience has shown that the useful lifetime often lies within a range of 8 to 12 years. It can, however, be significantly less if elements are operated near to their specification limits.

When plant/site experience indicates a shorter useful lifetime than indicated in this appendix, the number based on plant/site experience should be used.

¹⁶ Useful lifetime is a reliability engineering term that describes the operational time interval where the failure rate of a device is relatively constant. It is not a term which covers product obsolescence, warranty, or other commercial issues.

Appendix 3: *exida* Environmental Profiles

<i>exida</i> Profile	1	2	3	4	5	6
Description (Electrical)	Cabinet mounted/ Climate Controlled	Low Power Field Mounted no self-heating	General Field Mounted self-heating	Subsea	Offshore	N/A
Description (Mechanical)	Cabinet mounted/ Climate Controlled	General Field Mounted	General Field Mounted	Subsea	Offshore	Process Wetted
IEC 60654-1 Profile	B2	C3 also applicable for D1	C3 also applicable for D1	N/A	C3 also applicable for D1	N/A
Average Ambient Temperature	30°C	25°C	25°C	5°C	25°C	25°C
Average Internal Temperature	60°C	30°C	45°C	5°C	45°C	Process Fluid Temp.
Daily Temperature Excursion (pk-pk)	5°C	25°C	25°C	0°C	25°C	N/A
Seasonal Temperature Excursion (winter average vs. summer average)	5°C	40°C	40°C	2°C	40°C	N/A
Exposed to Elements/Weather Conditions	No	Yes	Yes	Yes	Yes	Yes
Humidity¹⁷	0-95% Non-Condensing	0-100% Condensing	0-100% Condensing	0-100% Condensing	0-100% Condensing	N/A
Shock¹⁸	10 g	15 g	15 g	15 g	15 g	N/A
Vibration¹⁹	2 g	3 g	3 g	3 g	3 g	N/A
Chemical Corrosion²⁰	G2	G3	G3	G3	G3	Compatible Material
Surge²¹						
Line-Line	0.5 kV	0.5 kV	0.5 kV	0.5 kV	0.5 kV	N/A
Line-Ground	1 kV	1 kV	1 kV	1 kV	1 kV	
EMI Susceptibility²²						
80MHz to 1.4 GHz	10V /m	10V /m	10V /m	10V /m	10V /m	N/A
1.4 GHz to 2.0 GHz	3V/m	3V/m	3V/m	3V/m	3V/m	
2.0Ghz to 2.7 GHz	1V/m	1V/m	1V/m	1V/m	1V/m	
ESD (Air)²³	6kV	6kV	6kV	6kV	6kV	N/A

¹⁷ Humidity rating per IEC 60068-2-3

¹⁸ Shock rating per IEC 60068-2-27

¹⁹ Vibration rating per IEC 60068-2-6

²⁰ Chemical Corrosion rating per ISA 71.04

²¹ Surge rating per IEC 61000-4-5

²² EMI Susceptibility rating per IEC 6100-4-3

²³ ESD (Air) rating per IEC 61000-4-2

Appendix 4: *exida* Route 2_H Criteria

IEC 61508:2010 2nd edition describes the Route 2_H alternative to Route 1_H architectural constraints.

The standard states:

"based on data collected in accordance with published standards (e.g., IEC 60300-3-2: or ISO 14224); and, be evaluated according to

- the amount of field feedback; and
- the exercise of **expert judgment**; and when needed
- the undertake of specific tests,

in order to estimate the average and the uncertainty level (e.g., the 90% confidence interval or the probability distribution) of each reliability parameter (e.g., failure rate) used in the calculations."

exida has interpreted this to mean not just a simple 90% confidence level in the uncertainty analysis, but a high confidence level in the entire data collection process. As IEC 61508:2010 2nd edition does not give detailed criteria for Route 2_H, *exida* has established the following:

1. field unit operational hours of 100,000,000 per each component; and
2. a device and all of its components have been installed in the field for one year or more; and
3. operational hours are counted only when the data collection process has been audited for correctness and completeness; and
4. failure definitions, especially "random" versus "systematic" are checked by *exida*; and
5. every component used in an FMEDA meets the above criteria.

This set of requirements is chosen to assure high integrity failure data suitable for safety integrity verification.

Appendix 5: Using the FMEDA results

The 9113 Temperature / mA converter together with a temperature sensing device becomes a temperature sensor assembly. Therefore, when using the results of this FMEDA in a SIL verification assessment, the failure rates and failure modes of the temperature sensing device must be considered.

Appendix 5.1: 9113 Temperature / mA converter with thermocouple

The failure mode distributions for thermocouples vary in published literature but there is strong agreement that open circuit or “burn-out” failure is the dominant failure mode. While some estimates put this failure mode at 99%+, a more conservative failure rate distribution suitable for SIS applications is shown in Table 6 and Table 7 when thermocouples are supplied with the 9113 Temperature / mA converter. The drift failure mode is primarily due to T/C aging.

The 9113 Temperature / mA converter will detect a thermocouple burn-out failure and drive its output to the specified failure state.

Table 6: Typical failure rates for thermocouples (with extension wire)

<i>Thermocouple Failure Mode Distribution</i>	<i>Low Stress</i>	<i>High Stress</i>
Open Circuit (Burn-out)	180 FIT	720 FIT
Short Circuit (Temperature measurement in error)	10 FIT	40 FIT
Drift (Temperature measurement in error)	10 FIT	40 FIT

Table 7: Typical failure rates for thermocouples (close coupled)

<i>Thermocouple Failure Mode Distribution</i>	<i>Low Stress</i>	<i>High Stress</i>
Open Circuit (Burn-out)	95 FIT	380 FIT
Short Circuit (Temperature measurement in error)	4 FIT	16 FIT
Drift (Temperature measurement in error)	1 FIT	4 FIT

Table 8: Thermocouple fault classification

Failure mode	Classification
Open circuit	Dangerous detected
Short circuit	Dangerous undetected
Drift	Dangerous undetected

A complete temperature sensor assembly consisting of the 9113 Temperature / mA converter and a temperature sensing device can be modeled by considering a series subsystem where a failure occurs if there is a failure in either component. For such a system, failure rates are added.

Assuming that the 9113 Temperature / mA converter will go to the pre-defined alarm state on detected failures of the thermocouple, the failure rate contribution for the thermocouple is:

Table 9: Thermocouple (with extension wire)

Low stress environment (extension wire)	High stress environment (extension wire)
$\lambda_{dd} = 180 \text{ FIT}$	$\lambda_{dd} = 720 \text{ FIT}$
$\lambda_{du} = 10 \text{ FIT} + 10 \text{ FIT} = 20 \text{ FIT}$	$\lambda_{du} = 40 \text{ FIT} + 40 \text{ FIT} = 80 \text{ FIT}$

Table 10: Thermocouple (close coupled)

Low stress environment (close coupled)	High stress environment (close coupled)
$\lambda_{dd} = 95 \text{ FIT}$	$\lambda_{dd} = 380 \text{ FIT}$
$\lambda_{du} = 4 \text{ FIT} + 1 \text{ FIT} = 5 \text{ FIT}$	$\lambda_{du} = 16 \text{ FIT} + 4 \text{ FIT} = 20 \text{ FIT}$

Appendix 5.2: 9113 Temperature / mA converter with RTD

The failure mode distribution for an RTD depends on the application with the key variables being stress level, presence (or not) of extension wire and wire configuration (2-wire/3-wire or 4-wire). The key stress variables are high vibration and frequent temperature cycling as these are known to cause cracks in the substrate leading to broken lead connection welds. Failure rate distributions are shown in Table 11 to Table 14.

The 9113 Temperature / mA converter will detect open circuit, short circuit and a certain percentage of drift RTD failures and drive their output to the specified failure state.

Table 11 Typical failure rates for 4-Wire RTDs (with extension wire)

RTD Failure Mode Distribution	Low Stress	High Stress
Open Circuit (Burn-out)	164 FIT	656 FIT
Short Circuit (Temperature measurement in error)	8 FIT	32 FIT
Drift (Temperature Measurement in error)	28 FIT ²⁴	112 FIT ²⁵

Table 12 Typical failure rates for 4-Wire RTDs (close coupled)

RTD Failure Mode Distribution	Low Stress	High Stress
Open Circuit (Burn-out)	41.5 FIT	166 FIT
Short Circuit (Temperature measurement in error)	2.5 FIT	10 FIT
Drift (Temperature Measurement in error)	6 FIT ²⁶	24 FIT ²⁷

Table 13 Typical failure rates for 2/3-Wire RTDs (with extension wire)

RTD Failure Mode Distribution	Low Stress	High Stress
Open Circuit (Burn-out)	75 FIT	299.5 FIT
Short Circuit (Temperature measurement in error)	2 FIT	7.7 FIT
Drift (Temperature Measurement in error)	19 FIT	76.8 FIT

Table 14 Typical failure rates for 2/3-Wire RTDs (close coupled)

RTD Failure Mode Distribution	Low Stress	High Stress
Open Circuit (Burn-out)	38 FIT	151.7 FIT
Short Circuit (Temperature measurement in error)	1.4 FIT	5.7 FIT
Drift (Temperature Measurement in error)	8.6 FIT	34.6 FIT

Table 15: RTD fault classification

Failure mode	Classification
Open circuit	Dangerous detected
Short circuit	Dangerous detected
Drift (2/3-Wire)	Dangerous undetected
Drift (4-Wire)	Most of it is dangerous detected, remaining part dangerous undetected (assuming a correct use of 4-wire RTD)

²⁴ It is assumed that 26 FIT are detectable if the 4-wire RTD is correctly used.

²⁵ It is assumed that 104 FIT are detectable if the 4-wire RTD is correctly used.

²⁶ It is assumed that 3.5 FIT are detectable if the 4-wire RTD is correctly used.

²⁷ It is assumed that 14 FIT are detectable if the 4-wire RTD is correctly used.

A complete temperature sensor assembly consisting of the 9113 Temperature / mA converter and a temperature sensing device can be modeled by considering a series subsystem where a failure occurs if there is a failure in either component. For such a system, failure rates are added.

Assuming that the 9113 Temperature / mA converter will go to the pre-defined alarm state on a detected failure of the RTD, the failure rate contribution for the RTD is:

4-wire RTD with extension wire:

Low stress environment	High stress environment
$\lambda_{dd} = 164 \text{ FIT} + 8 \text{ FIT} + 26 \text{ FIT} = 198 \text{ FIT}$	$\lambda_{dd} = 656 \text{ FIT} + 32 \text{ FIT} + 104 \text{ FIT} = 792 \text{ FIT}$
$\lambda_{du} = 2 \text{ FIT}$	$\lambda_{du} = 8 \text{ FIT}$

4-wire RTD close coupled:

Low stress environment	High stress environment
$\lambda_{dd} = 41.5 \text{ FIT} + 2.5 \text{ FIT} + 3.5 \text{ FIT} = 47.5 \text{ FIT}$	$\lambda_{dd} = 166 \text{ FIT} + 10 \text{ FIT} + 14 \text{ FIT} = 190 \text{ FIT}$
$\lambda_{du} = 2.5 \text{ FIT}$	$\lambda_{du} = 10 \text{ FIT}$

2/3-wire RTD with extension wire:

Low stress environment	High stress environment
$\lambda_{dd} = 75 \text{ FIT} + 2 \text{ FIT} = 77 \text{ FIT}$	$\lambda_{dd} = 299.5 \text{ FIT} + 7.7 \text{ FIT} = 307.2 \text{ FIT}$
$\lambda_{du} = 19 \text{ FIT}$	$\lambda_{du} = 76.8 \text{ FIT}$

2/3-wire RTD close coupled:

Low stress environment	High stress environment
$\lambda_{dd} = 38 \text{ FIT} + 1.4 \text{ FIT} = 39.4 \text{ FIT}$	$\lambda_{dd} = 151.7 \text{ FIT} + 5.7 \text{ FIT} = 157.4 \text{ FIT}$
$\lambda_{du} = 8.6 \text{ FIT}$	$\lambda_{du} = 34.6 \text{ FIT}$